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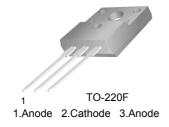
# FFPF12UP20DP Ultrafast Recovery Power Rectifier

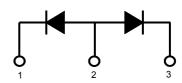
## **Features**

- Ultrafast with Soft Recovery : < 35ns (@I<sub>F</sub> = 6A)
- High Reverse Voltage : V<sub>RRM</sub> = 200V
- · Enhanced Avalanche Energy Rated
- Planar Construction

## **Applications**

- · Output Rectifiers
- · Switching Mode Power Supply
- · Free-wheeling Diode
- · Power Switching Circuits





1. Cathode 2. Anode 3. Cathode

## Absolute Maximum Ratings (per diode) T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	200	V
V <sub>RWM</sub>	Working Peak Reverse Voltage	200	V
V <sub>R</sub>	DC Blocking Voltage	200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 120°C	6	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	60	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

## **Thermal Characteristics**

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	5.0	°C/W

## **Package Marking and Ordering Information**

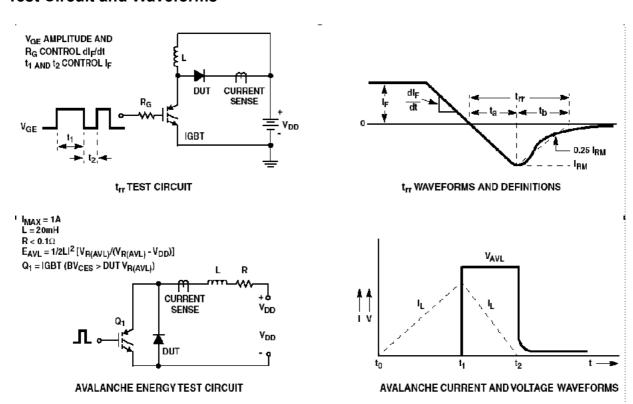
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F12UP20DP	FFPF12UP20DPTU	TO-220F	-	-	50

# **Electrical Characteristics** (per diode) T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	I <sub>F</sub> = 6A I <sub>F</sub> = 6A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-	-	1.15 1.0	V V
I <sub>RM</sub> *	V <sub>R</sub> = 200V V <sub>R</sub> = 200V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-	-	100 500	μΑ μΑ
t <sub>rr</sub>	$I_F$ =1A, di/dt = 100A/ $\mu$ s, $V_{CC}$ = 30V $I_F$ =6A, di/dt = 200A/ $\mu$ s, $V_{CC}$ = 130V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C	-	-	30 35	ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	$I_F = 6A$ , di/dt = 200A/ $\mu$ s, $V_{CC} = 130V$	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 25 ^{\circ}\text{C}$		12 12 24	- - -	ns ns nC
W <sub>AVL</sub>	Avalanche Energy (L = 20mH)		10	-	-	mJ

 $<sup>^{\</sup>star}$  Pulse Test: Pulse Width=300  $\mu s,$  Duty Cycle=2%

## **Test Circuit and Waveforms**



## **Typical Performance Characteristics**

Figure 1. Typical Forward Voltage Drop

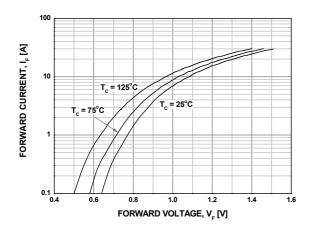


Figure 2. Typical Reverse Current

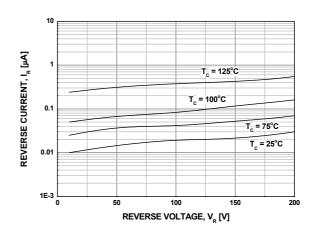


Figure 3. Typical Junction Capacitance

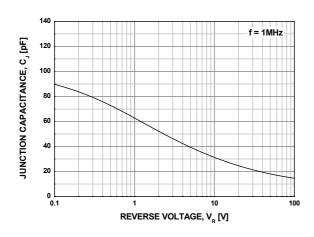


Figure 4. Typical Reverse Recovery Time

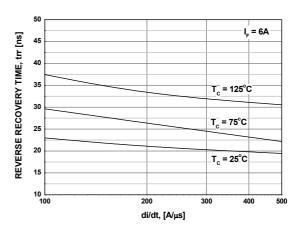
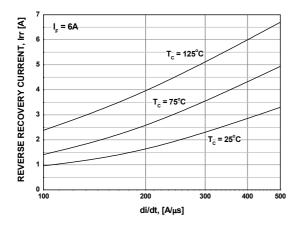
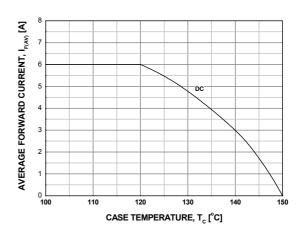


Figure 5. Typical Reverse Recovery Current

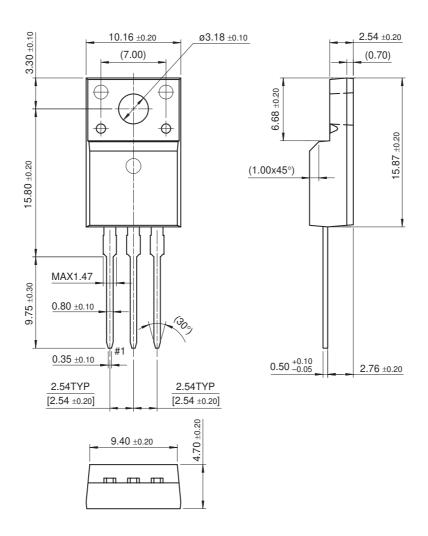


**Figure 6. Forward Current Deration Curve** 



# **Package Demensions**

# TO-220F



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FACT™	IntelliMAX™	OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	VCX™
FACT Quiet Series™		OPTOPLANAR™	SMART START™	Wire™
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Across the board. Arour	ia trie woria. ''''	DODIM	Stoolth TM	

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Rev I18